Suh,

- 1. A photoresist composition comprising a photoactive component and a resin that comprises a polymer that comprises 1) an acid-labile group; 2) a metahydroxyphenyl group, and 3) a para-hydroxyphenyl group.
- 2. The photoresist of claim 1 wherein the polymer comprises pendant acrylate acid-labile groups.
- 3. The photoresist of claim 1 wherein the polymer comprises a structure of Formula I:

wherein W comprises an acid-labile group;

R¹ and R² are each the same or different non-hydrogen substituents;

R³, R⁴ and R⁵ are each independently hydrogen or optionally substituted alkyl; m and n are each independently 0 to 4; and

I

x, y and z are each greater than 0 and are mole percents of the respective units of the polymer.

- 4. The photoresist of claim 3 wherein W comprises an acrylate ester.
- 5. The photoresist of claim 3 wherein the sum of x, y and z is at least about 90 mole percent of total units of the polymer.



$$\bigcap_{\mathsf{C}} \mathsf{C}^{\mathsf{R}^3} \bigvee_{\mathsf{W}} \mathsf{C}^{\mathsf{R}^4} \bigvee_{\mathsf{X}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{Y}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{Y}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{C}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{C}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{C}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{C}} \mathsf{C}^{\mathsf{R}^5} \bigvee_{\mathsf{C}} \mathsf{C}^{\mathsf{C}^5} \bigvee_{\mathsf{C}^{\mathsf{C}^5}} \bigvee_{\mathsf{C}^{\mathsf{C}^5} \bigvee_{\mathsf{C}^{\mathsf{C}^5}} \mathsf{C}^{\mathsf{C}^5} \bigvee_{\mathsf{C}^{\mathsf{C}^5}} \bigvee_{\mathsf{C}^{\mathsf{C}^5} \bigvee_{\mathsf{C}^{\mathsf{C}$$

II

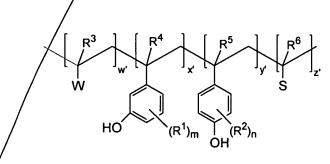
wherein R is optionally substituted alkyl;

R¹ and R² are each the same or different non-hydrogen substituents;

R³, R⁴ and R⁵ are each independently hydrogen or optionally substituted alkyl; m and n are each independently 0 to 4; and

w, x and y are each greater than 0 and are mole percents of the respective units of the polymer.

- 7. The photoresist of claim 6 wherein the sum of w, x and y is at least about 90 mole percent of total units of the polymer.
- 8. The photoresist of claim 1 wherein the polymer comprises a structure represented by the following Formula III:



III

wherein W comprises an acid-labile group;



ij jj

ij

ijĮ

R¹ and R² are each the same or different non-hydrogen substituents;

R³, R⁴, R⁵ and R⁶ are each independently hydrogen or optionally substituted alkyl; m and n are each independently 0 to 4; and

S is a group that does not contain acidic or acid-reactive moieties;

w', x', y' and z' are each greater than 0 and are mole percents of the respective polymer units.

- 9. A photoresist of claim 8 wherein the sum of w', x', y' and z' is at least about 90 mole percent of total units of the polymer.
- 10. A photoresist of claim 1 wherein the polymer comprises a structure of the following Formula IV:

wherein R is optionally substituted alkyl;

 $R^{1'}$, $R^{2'}$ and $R^{3'}$ are each independently hydrogen or methyl;

w, x, and y are each greater than 0 and are mole percents of the respective units of the polymer.

- 11. A photoresist of claim 10 wherein R is tert-butyl group, adamantyl, tetrahydropyranal, or norbornyl.
- 12. A photoresist of claim 10 wherein the sum of w, x, and y is at least about 90 mole percent of total units of the polymer.

- 13. A method for forming a photoresist relief image, comprising:
- a) applying a layer of a photoresist composition of claim 1 on a substrate; and
- b) exposing and developing the photoresist layer on the substrate to yield a photoresist relief image.
- 14. The method of claim 13 wherein the substrate is a microelectronic wafer or a flat panel display substrate.
- An article of manufacture comprising a substrate having coated thereon a photoresist composition of claim 1.
- 16. An article of claim 15 wherein the substrate is a microelectronic wafer or a flat panel display substrate
- A polymer that comprises 1) acid-labile groups; 2) meta-hydroxystyrene groups, and 3) para-hydroxyphenyl groups.
- A polymer of claim 17 wherein the polymer comprises a structure represented by the following Formula I:

$$\begin{array}{c|c}
& R^3 \\
& R^4 \\
& R^5 \\
& R^6 \\
&$$

I

wherein W comprises an acid-labile group;

 R^1 and R^b_i are each the same or different non-hydrogen substituents;

R³, R⁴ and R⁵ are each independently hydrogen or optionally substituted alkyl; m and n are each independently 0 to 4; and

x, y and z are each greater than 0 and are mole percents of the respective polymer units.

- 19. A polymer of claim 18 wherein W comprises an acrylate ester, and the sum of x, y and z is at least about 90 mole percent of total units of the polymer.
- 20. A polymer of claim 17 wherein the polymer comprises a structure represented by the following Formula IV:

wherein R is optionally substituted alkyl;

R1', R2' and R3' are each independently hydrogen or methyl;

w, x, and y are each greater than 0 and are mole percents of the respective units of the polymer.

0.001, 10.01, 10